MCU_RF_WL3R_QFN32

MB2339

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Sheet 5 : RF front-end

Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.

Notes to generate the board layout.

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HW2

STICKER PRODUCT

N/A

HW3

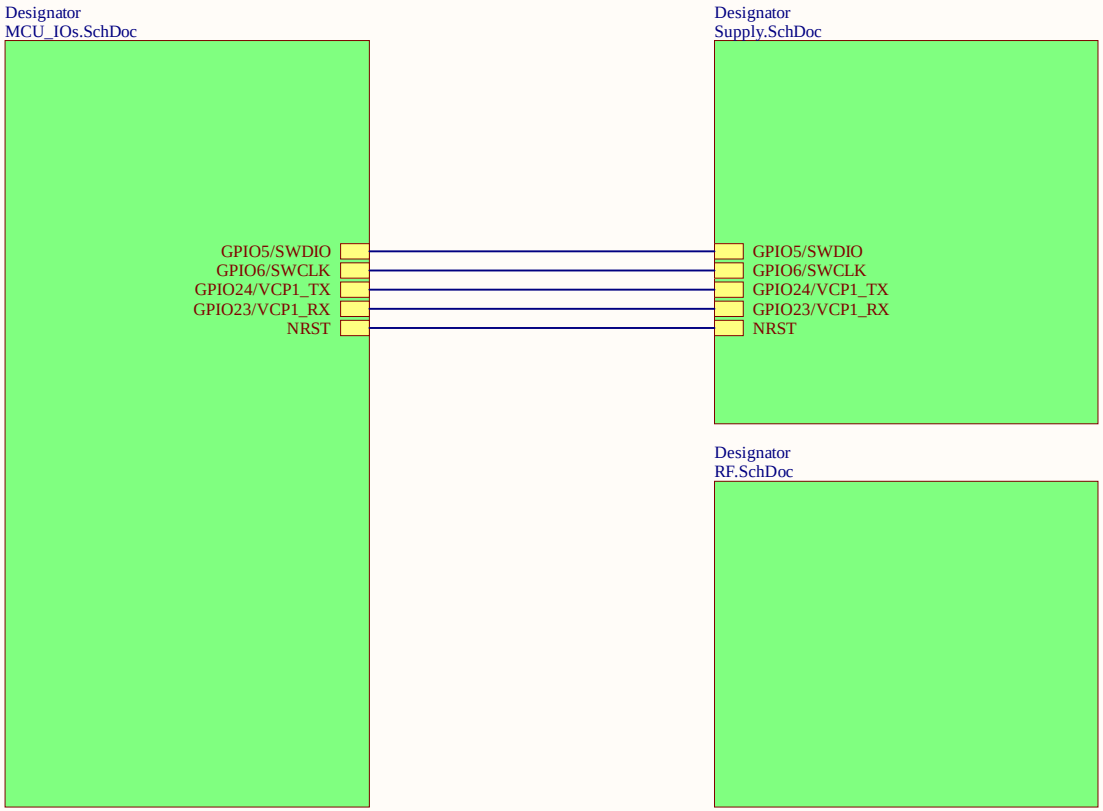
PCB

MB2339

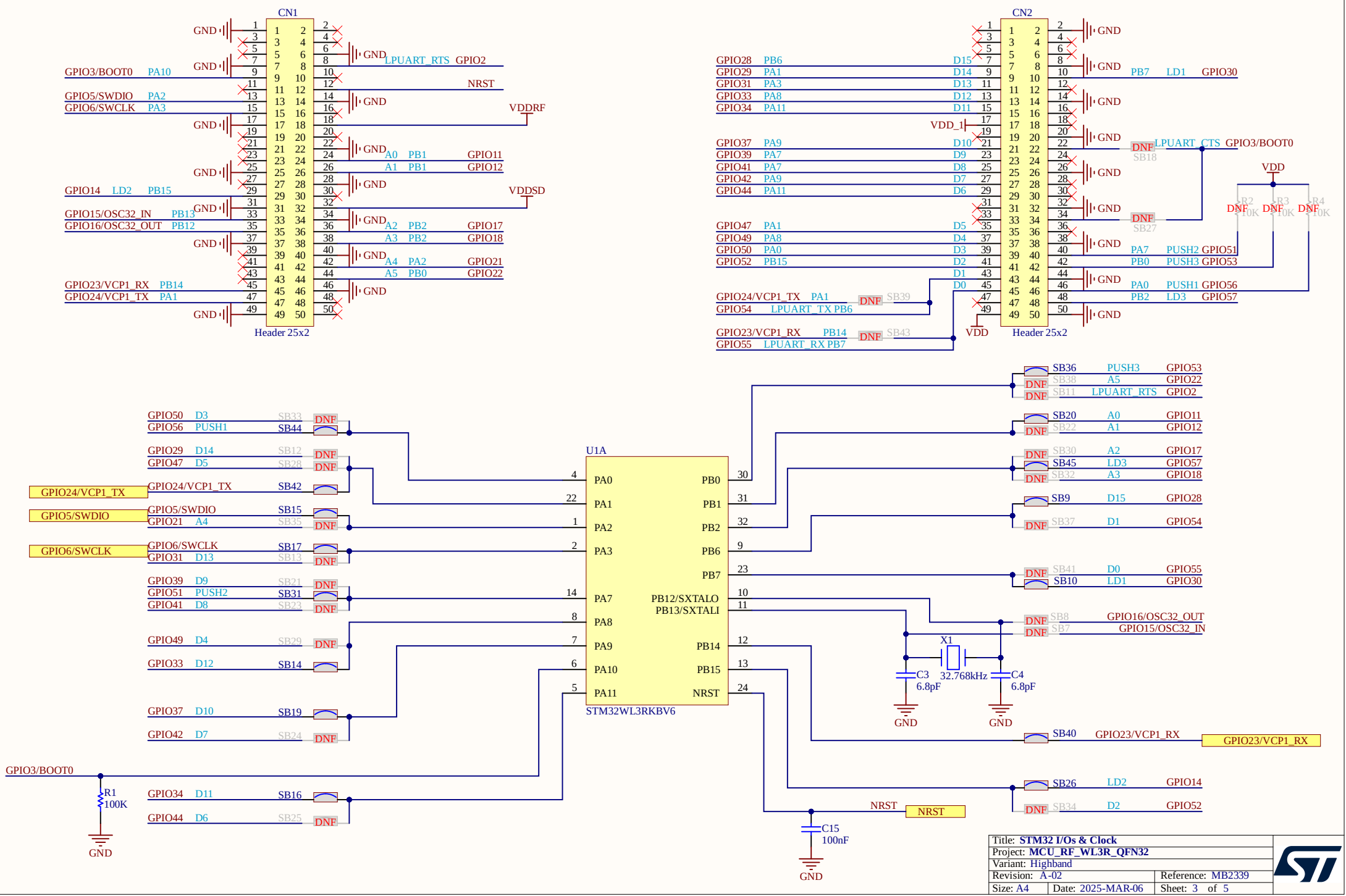
U_Top

Top.SchDoc

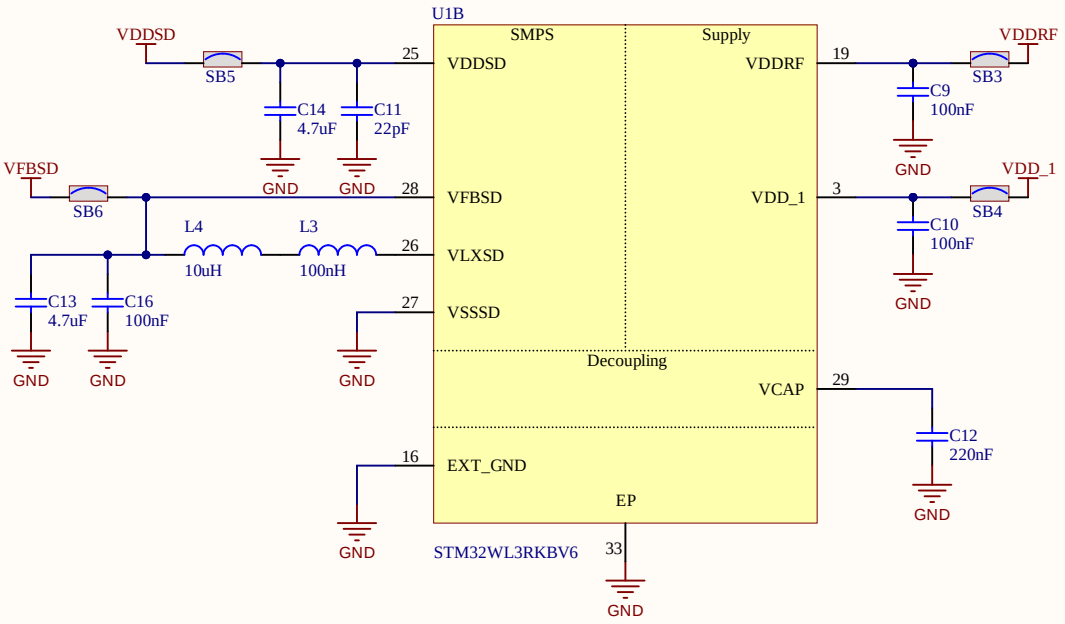
Title: **Project Overview**			
Project: **MCU_RF_WL3R_QFN32**			
Variant: Highband			
Revision: A-02		Reference: MB2339	
Size: A4	Date: 2025-MAR-06	Sheet: 1 of 5	

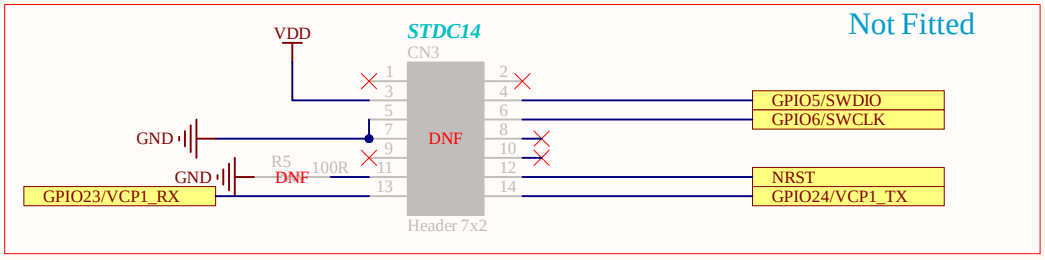


Title: **Top Schematic**		
Project: **MCU_RF_WL3R_QFN32**		
Variant: Highband		
Revision: A-02		Reference: MB2339
Size: A4	Date: 2025-MAR-06	Sheet: 2 of 5

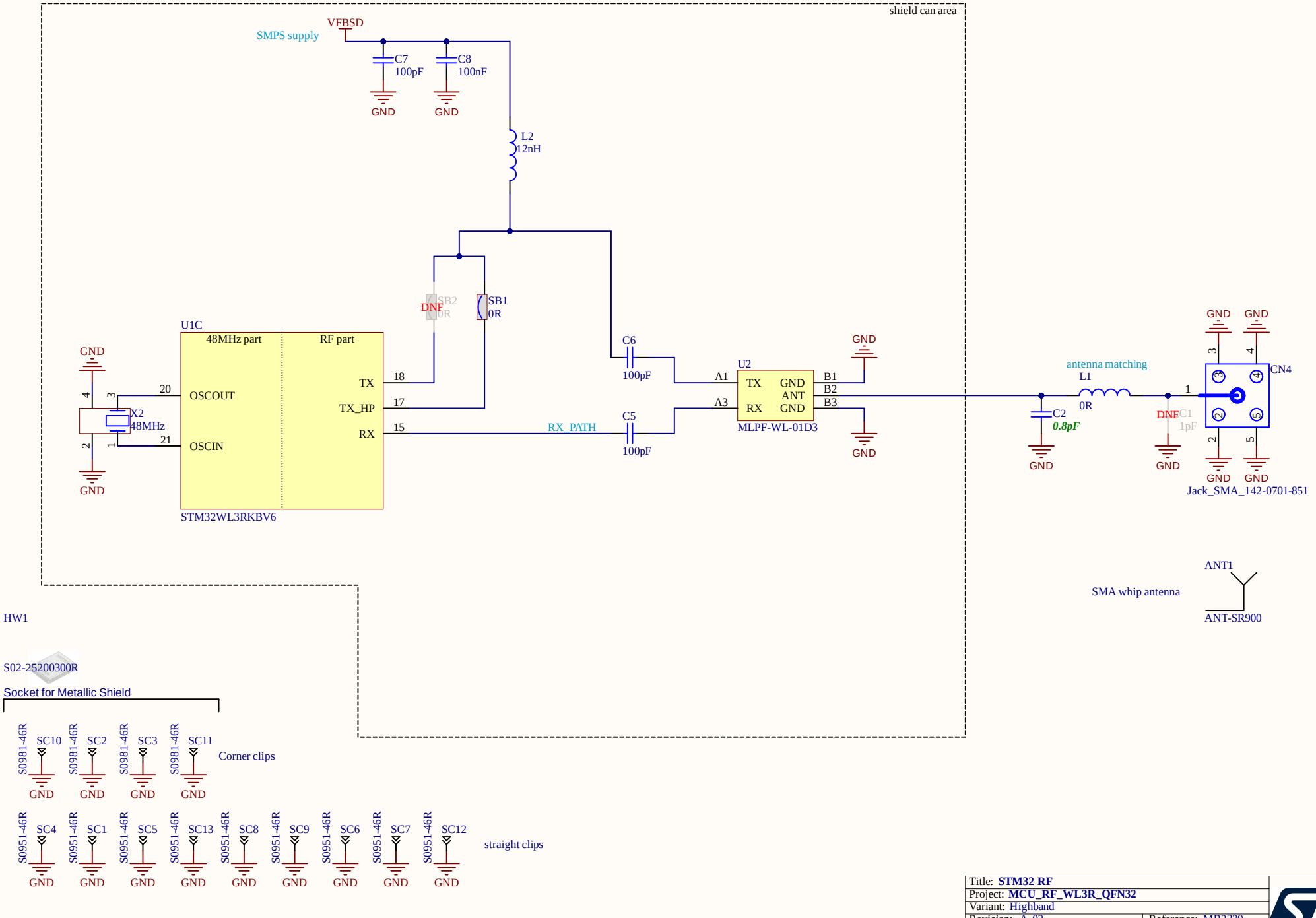


Title: **STM32 I/Os & Clock**		
Project: **MCU_RF_WL3R_QFN32**		
Variant: Highband		
Revision: A-02		Reference: MB2339
Size: A4	Date: 2025-MAR-06	Sheet: 3 of 5

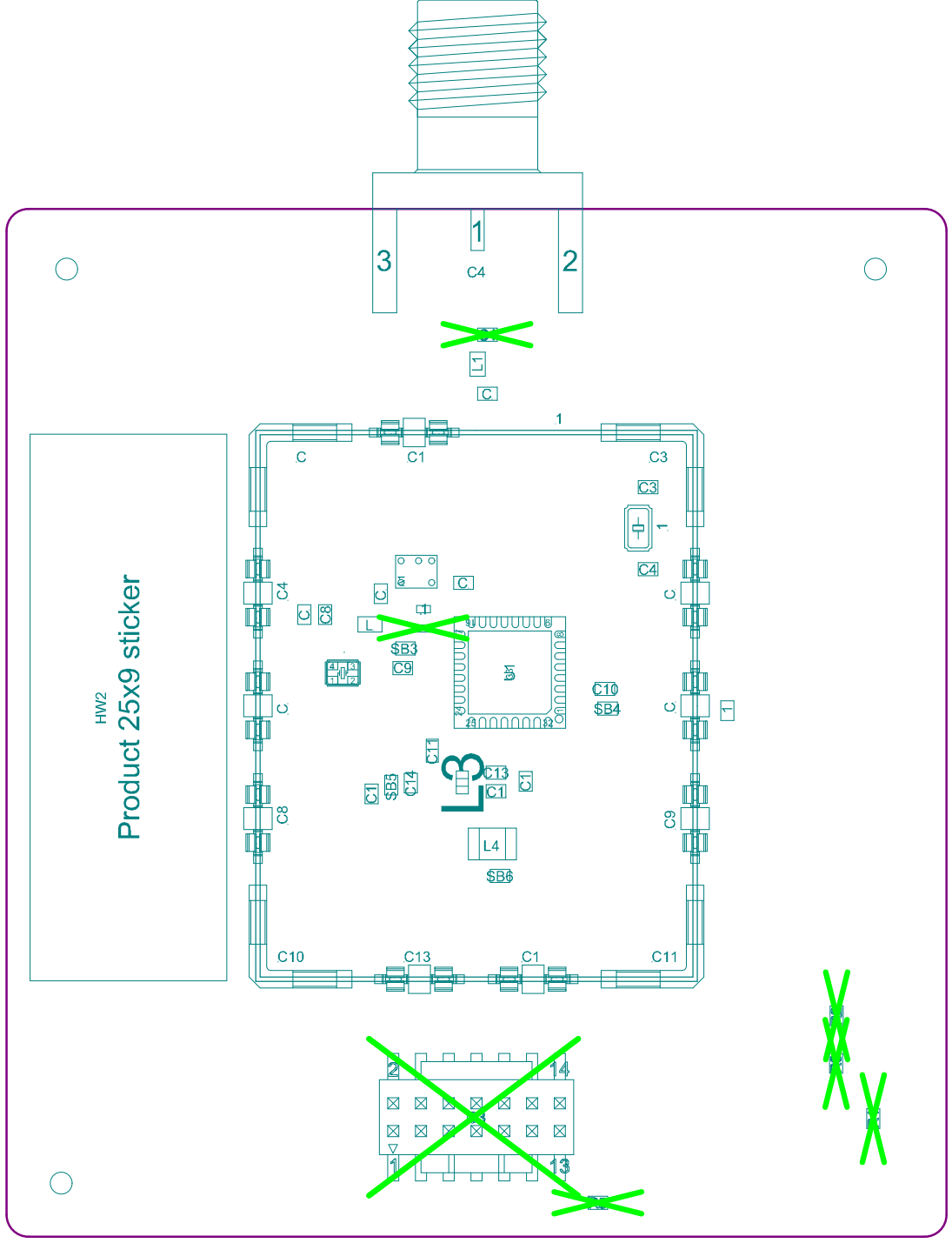




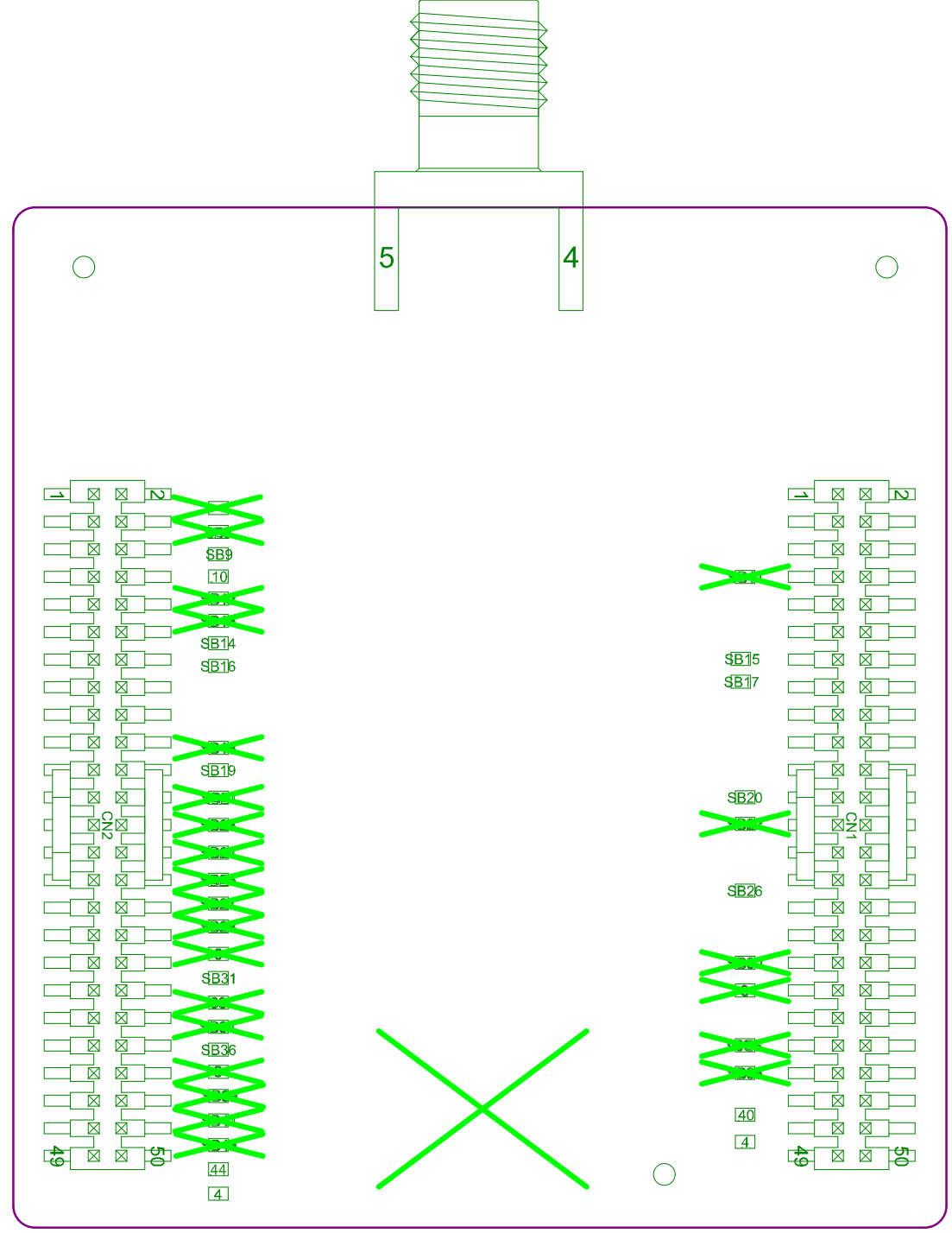
Title: **STM32 power**		
Project: **MCU_RF_WL3R_QFN32**		
Variant: Highband		
Revision: A-02		Reference: MB2339
Size: A4	Date: 2025-MAR-06	Sheet: 4 of 5



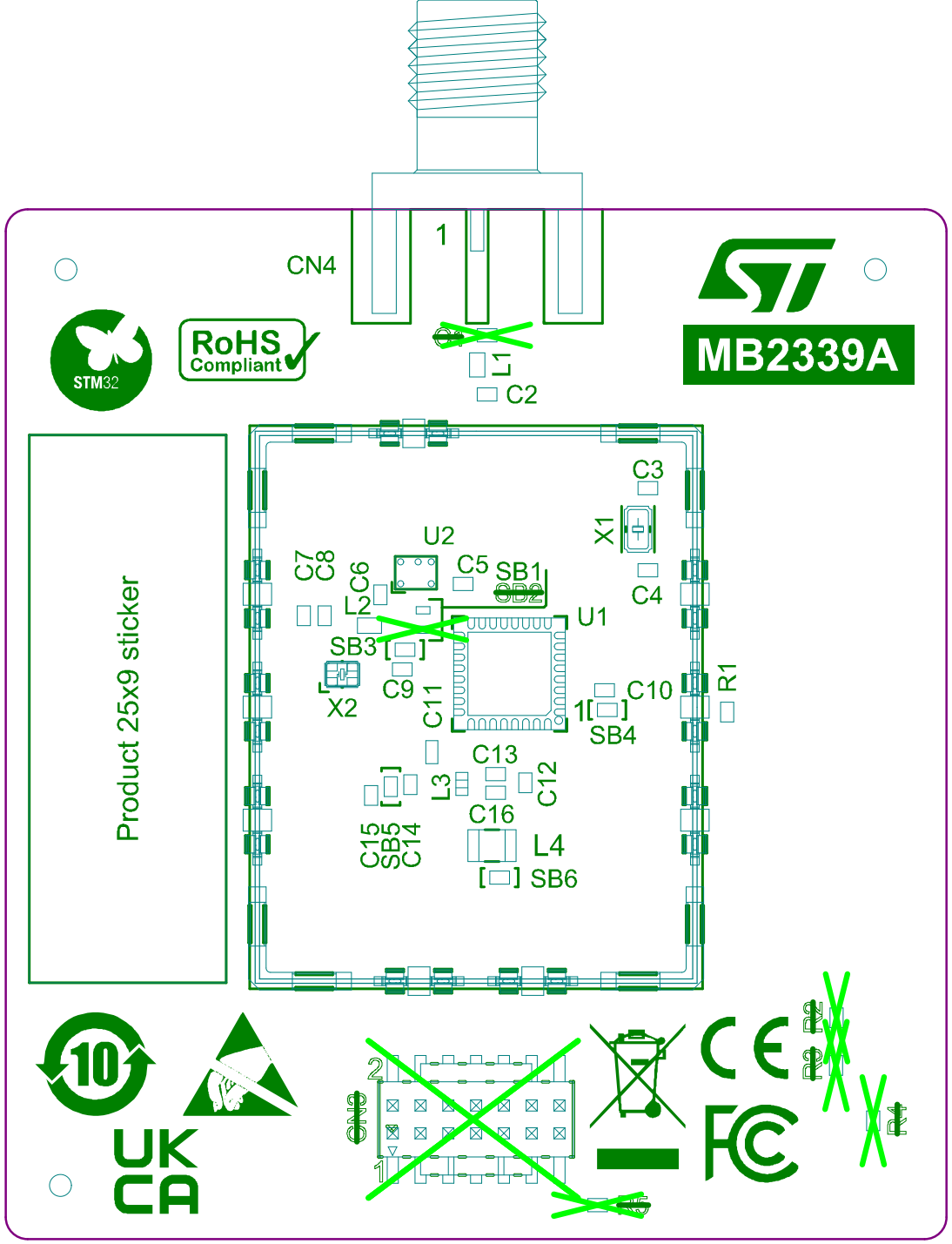
Title: **STM32 RF**		
Project: **MCU_RF_WL3R_QFN32**		
Variant: Highband		
Revision: A-02		Reference: MB2339
Size: A4	Date: 2025-MAR-06	Sheet: 5 of 5



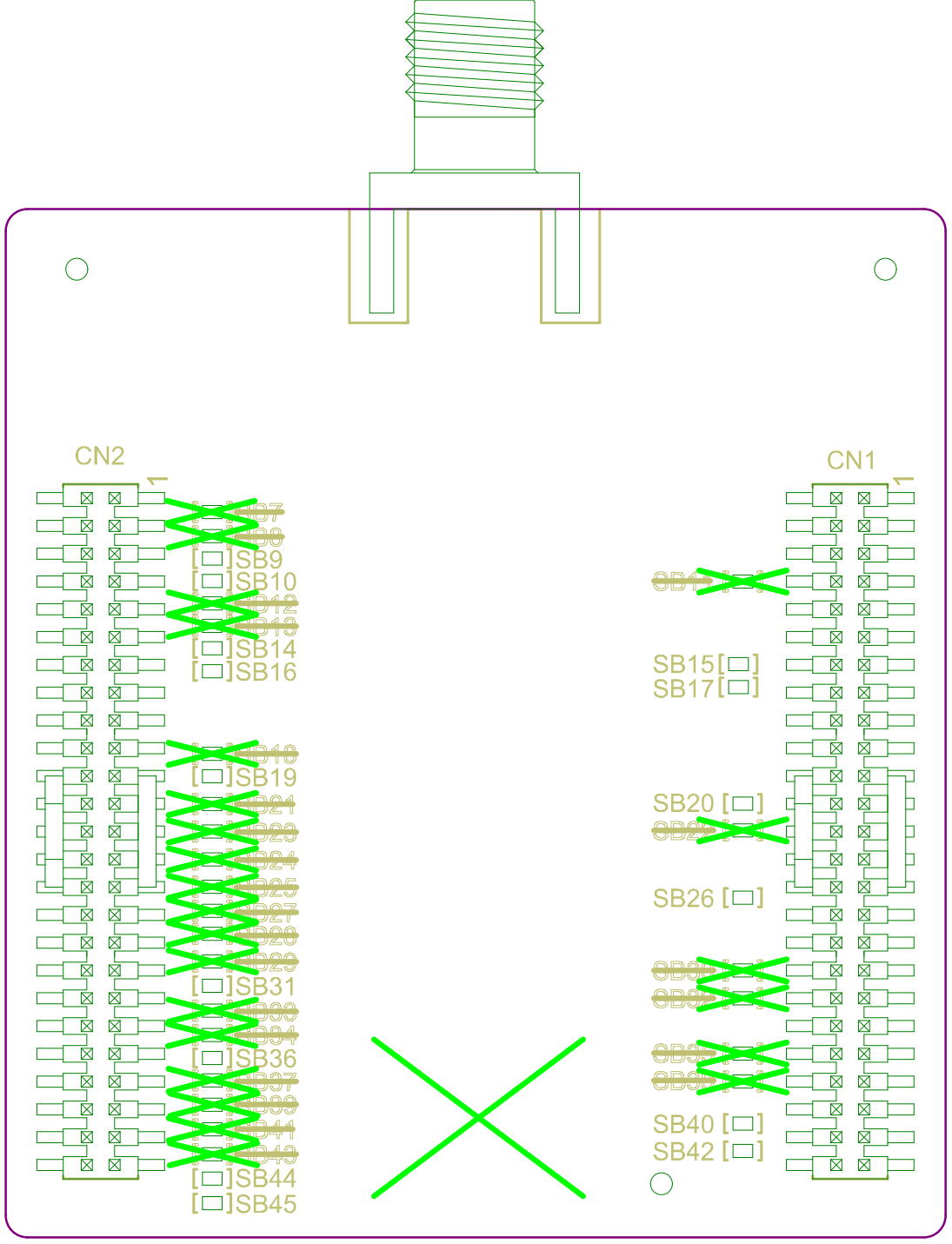
Project: MCU_RF_WL3R_QFN32	
Layer: M14-Top Assembly	Gerber: .GM14
Variant: Highband	Ref: MB2339
Date: 2025-MAR-06	Rev: A



Project: MCU_RF_WL3R_QFN32	
Layer: M15-Bottom Assembly	Gerber:.GM15
Variant: Highband	Ref: MB2339
Date: 2025-MAR-06	Rev: A



Top Overlay .GTO



Bottom Overlay .GBO